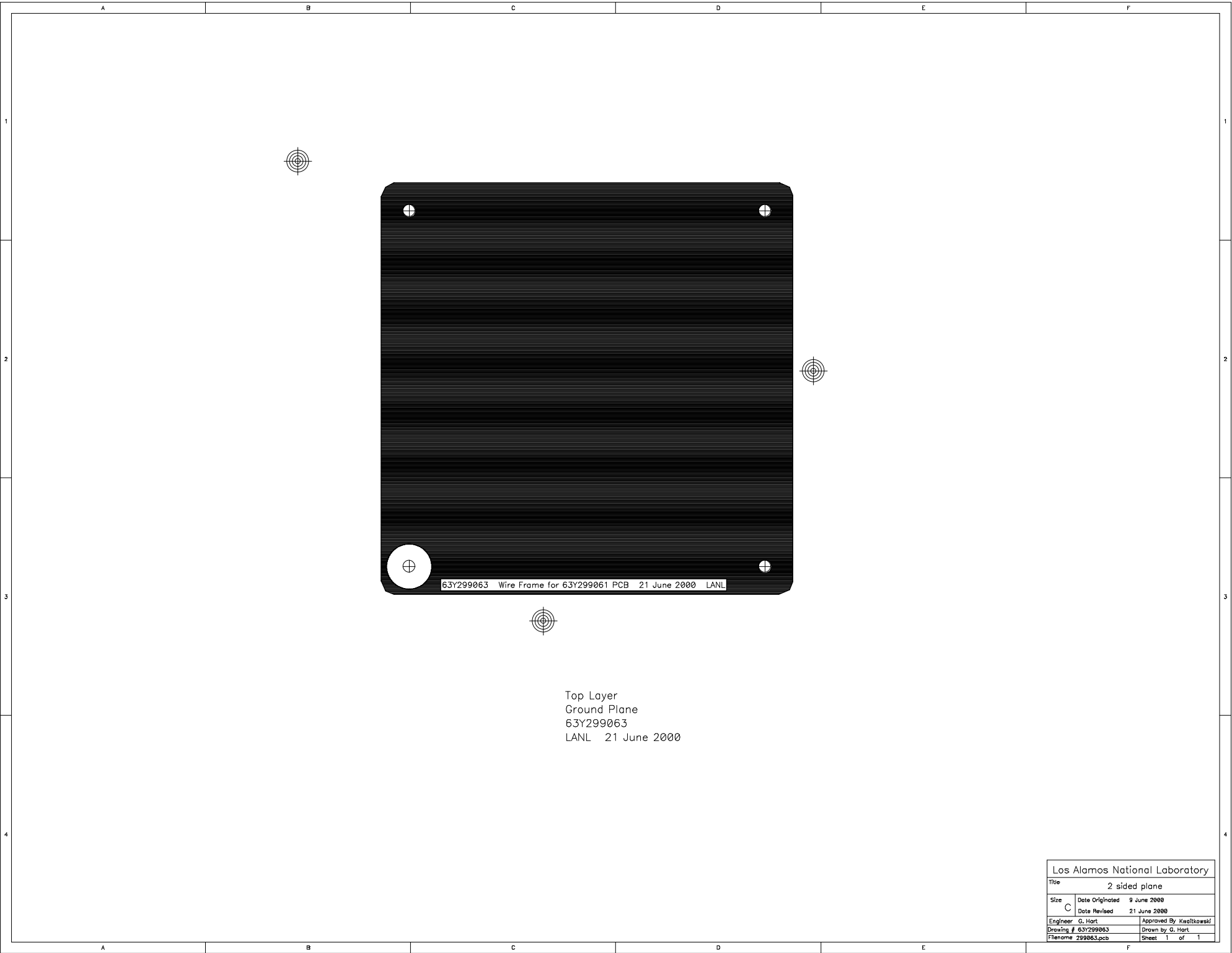


- Notes:
1. Board material to be FR4
 2. Board thickness after plating: .020" +/- .005"
 3. Trim card to dimensions shown
 4. all holes plated through w/ 1 oz copper
 5. overall finish to be .8um gold over 2.5um nickel
Use plating process that will yield the smoothest finish commercially possible
 6. Tolerance unless otherwise specified is +/- 5 mil

Drill Symbol Table		
Hole Dia (inch)	Symbol	Quantity
0.220	+	4

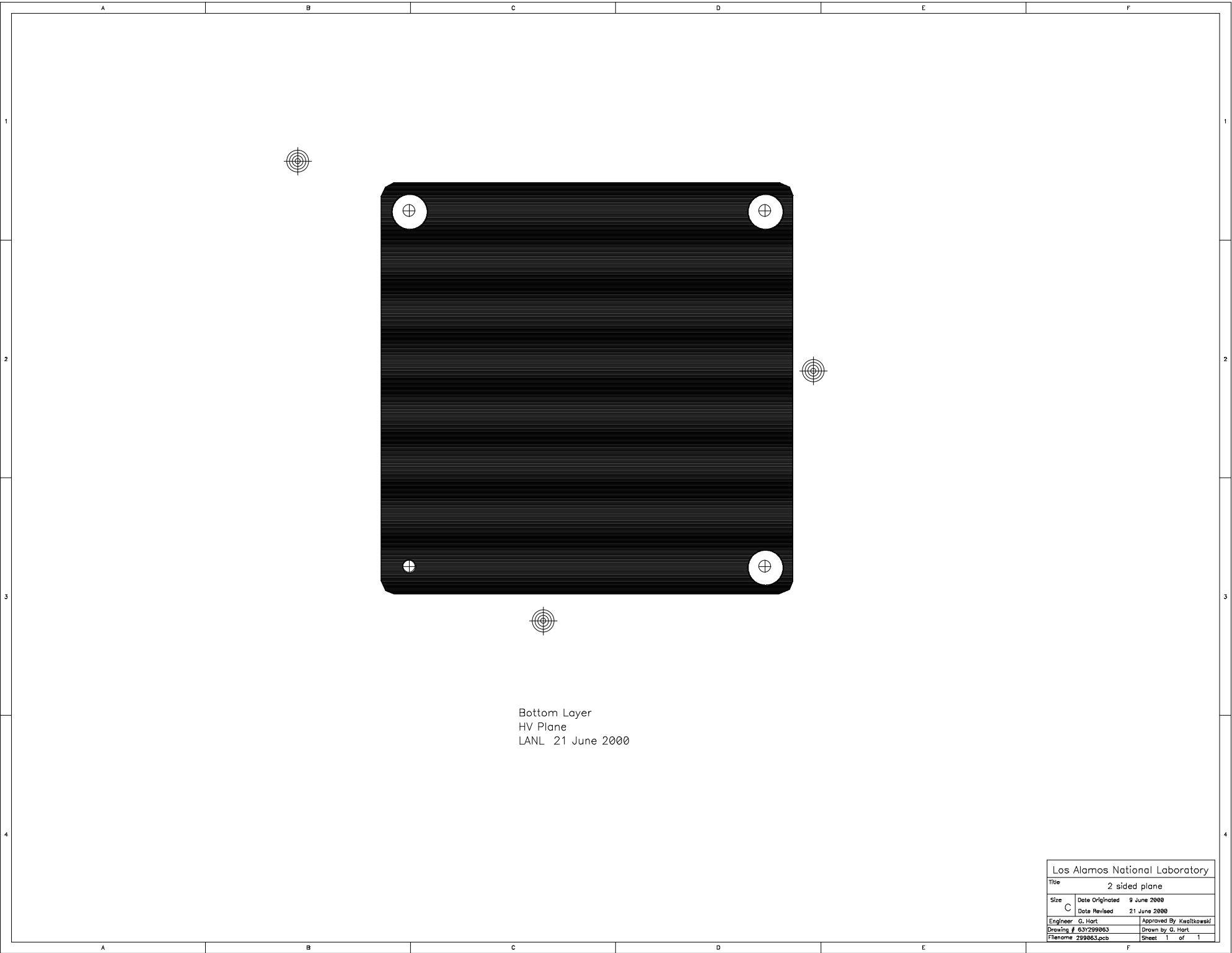
Los Alamos National Laboratory			
Title 2 sided plane			
Size C	Date Originated 9 June 2000	Date Revised 21 June 2000	
Engineer G. Hart	Approved By Kwatkowski		
Drawing # 63Y299063	Drawn by G. Hart		
Filename 2000063.pcb	Sheet 1	of 1	



63Y299063 Wire Frame for 63Y299061 PCB 21 June 2000 LANL

Top Layer
Ground Plane
63Y299063
LANL 21 June 2000

Los Alamos National Laboratory			
Title		2 sided plane	
Size C	Date Originated	9 June 2000	
	Date Revised	21 June 2000	
Engineer G. Hart		Approved By Kwiatkowski	
Drawing # 63Y299063		Drawn by G. Hart	
Filename 299063.pcb		Sheet 1 of 1	



Bottom Layer
HV Plane
LANL 21 June 2000

Los Alamos National Laboratory			
Title		2 sided plane	
Size C	Date Originated	9 June 2000	
	Date Revised	21 June 2000	
Engineer G. Hart		Approved By Kwiatkowski	
Drawing # 637299063		Drawn by G. Hart	
Filename 299063.pcb		Sheet	1 of 1